


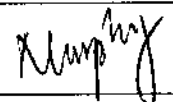

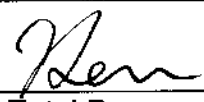
# DATA IMAGE CORPORATION

## LCD Module Specification

ITEM NO.: GM123200SFAYA-01

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R&D Dept.	Q.C. Dept.	Eng. Dept.	Prod. Dept.
			
Version:	Issued Date:	Sheet Code:	Total Pages:
	2002/7/11		22

## 2. RECORD OF REVISION

Rev	Date	Item	Page	Comment
B	OCT/18/01	7	9-10	1. Change VDD from 4.7V~5.5V to 2.7V~ 5.5V.
C	MAY/07/02	8,10	11-12	Correct 1. pin 19 from LED A to VLED 1. 2. pin20 from LED A to VLED 2.
	JUL/11/02	13	19	Change: P/N from GM12321S1LY-J2 to GM123200SFAYA-01

### 3. GENERAL SPECIFICATION

Display Format : 122dots (W) × 32dots (H)  
Dot Size : 0.4 (W) × 0.45 (H) mm  
View Area : 62.2 (W) × 17.9 (H) mm  
General Dimensions : 84 (W) × 44 (H) × 14.5 (T) mm Max.  
Weight : 40 g max.

LCD Type :  STN Gray  STN Yellow  FSTN

Polarizer mode :  Reflective  Transflective  
 Transmissive  Negative

View Angle :  6 O'clock  12 O'clock  Others \_\_\_\_\_

Backlight :  LED  EL  CCFL

Backlight Color :  Yellow green  Amber  Blue Green  
 White  Others

Controller / Driver : SED1520DAA

Temperature Range :  Normal  Wide Temperature  
Operating 0 to 50°C Operating -20 to 70°C  
Storage -20 to 70°C Storage -30 to 80°C

## 4. ABSOLUTE MAXIMUM RATINGS

### 4.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

$V_{SS} = 0V$ ,  $T_a = 25^{\circ}C$

Item	Symbol	Min.	Max.	Unit
Supply Voltage (Logic)	VDD-VSS	0	8	V
Supply Voltage (LCD Driver)	VDD-VEE	0	16.5	V
Input Voltage	V <sub>I</sub>	V <sub>SS</sub> -0.3	V <sub>DD</sub> +0.3	V
Operating Temperature	T <sub>OP</sub>	0	50	°C
Storage Temperature	T <sub>STG</sub>	-20	70	°C

### 4.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

Item	Operating		Storage		Comment
	(Min.)	Max.)	(Min.)	(Max.)	
Ambient Temp	0	50	-20	70	Note (1)
Humidity	Note (2)		Note(2)		Without Condensation
Vibration	--	4.9M/S <sup>2</sup>	--	19.6M/S <sup>2</sup>	XYZ Direction
Shock	--	29.4M/S <sup>2</sup>	--	490M/S <sup>2</sup>	XYZ Direction

Note(1)  $T_a = 0^{\circ}C$  : 50Hr Max.

Note(2)  $T_a \leq 40^{\circ}C$  : 90% RH Max.

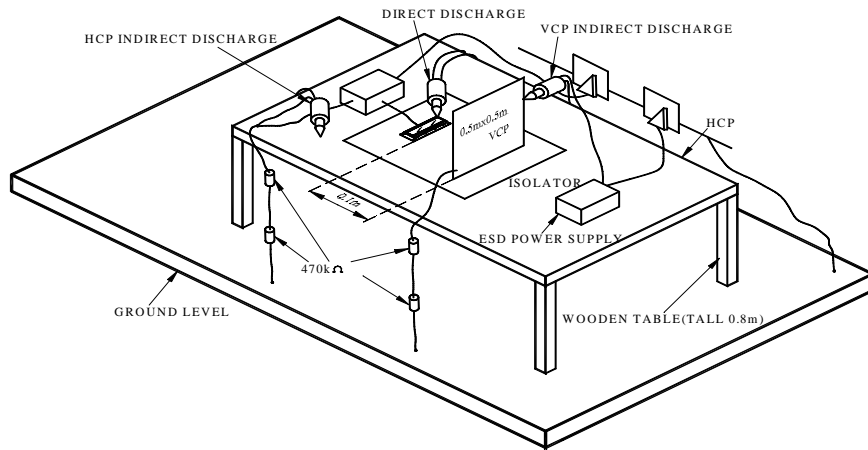
$T_a \geq 40^{\circ}C$  : Absolute humidity must be lower than the humidity of 90% RH at 40°C.

### 4.3 Electronic Static Discharge maximum rating

ESD test method : IEC1000-4-2

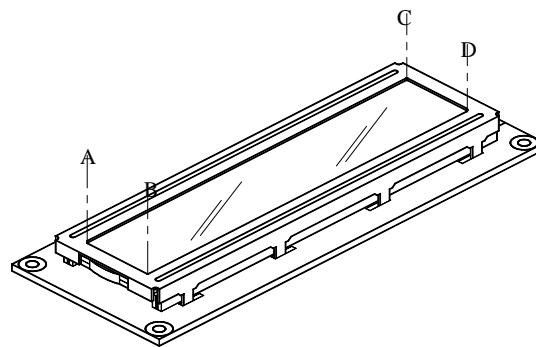
Item	Description	
Testing environment	Ambient temperature : 15°C to 35 °C Humidity: 30% to 60 % LCM ( E.U.T ) : Power up	
Testing equipment	Manufacture: NoiseKen, Model No. ESD-100L	
Testing condition	See drawing 1	
Direct discharge	0 to ± 6 KV	Discharge point, see drawing 2
Indirect discharge	0 to ± 12KV	Discharge point, see drawing 1
Pass condition	No malfunction of unit. Temporary malfunction of unit which can be recovered by system reset	
Fail condition	Non. Recoverable malfunction of LCM or system	

FIG 1 ESD TESTING EQUIPMENT



(1)

### DIRECT CONTACT DISCHARGE CONTACT POINT : A.B.C.D



(2)

## 5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage (Logic)	VDD-VSS		2.7	5.0	5.5	V
Supply Voltage (LCD)	VDD-VEE	0°C	6.1	6.7	7.5	V
		25°C	5.6	6.2	7.0	
		50°C	5.1	5.7	6.5	
Input Voltage	V <sub>IH</sub>	--	V <sub>SS</sub> +2.0	--	V <sub>DD</sub>	V
	V <sub>IL</sub>		V <sub>SS</sub>	--	V <sub>SS</sub> +0.8	
Logic Supply Current	I <sub>DD</sub>	VDD-VSS=5V	--	1.2	--	mA

## 6. ELECTRO-OPTICAL CHARACTERISTICS

ITEM	Symbol	Condition	Min.	Typ.	Max.	Unit	Ref.
Rise Time	Tr	0°C	--	500	800	ms	Note (1)
		25°C		120	240		
Fall Time	Tf	0°C	--	1000	1500	ms	
		25°C		200	350		
Contrast	CR	25°C	3	4	--		Note (3)
View Angle	θ <sub>1</sub> ~θ <sub>2</sub> ∅ <sub>1</sub> , ∅ <sub>2</sub>	25°C & CR≥1.5	--	--	80		Note (2)
			-30	--	30		
Frame Frequency	Ff	25°C	--	64	--	Hz	

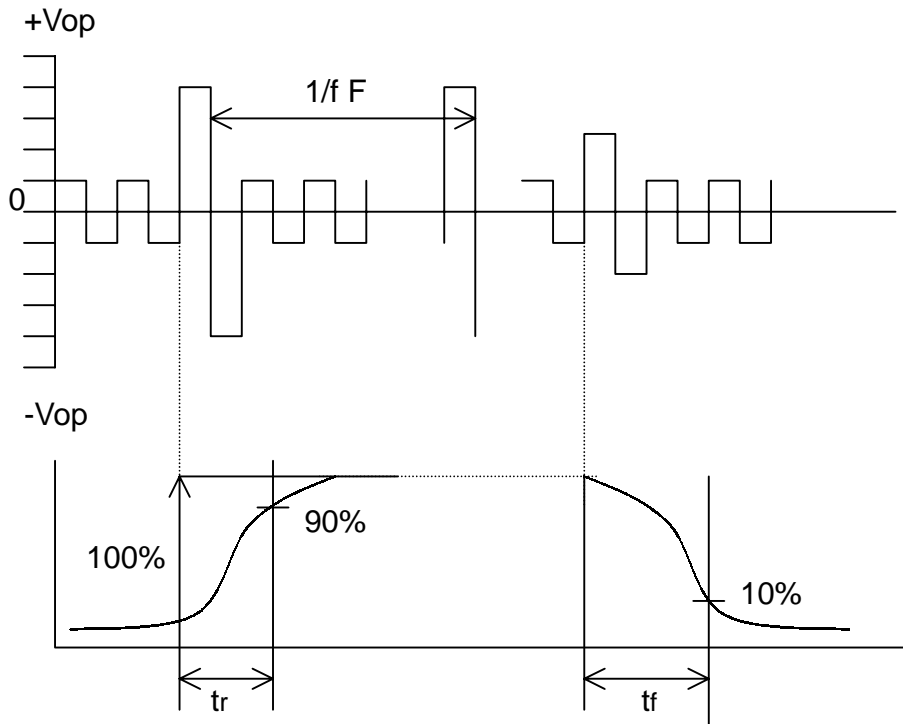
Note (1) & (2) : See next page

Note (3) : Contrast ratio is defined under the following condition:

$$CR = \frac{\text{Brightness of non-selected condition}}{\text{Brightness of selected condition}}$$

- ( a ). Temperature ----- 25°C
- ( b ). Frame frequency ---- 64Hz
- ( c ). Viewing angle ----- θ= 0°, ∅ = 0°
- ( d ). Operating voltage ---6.2V

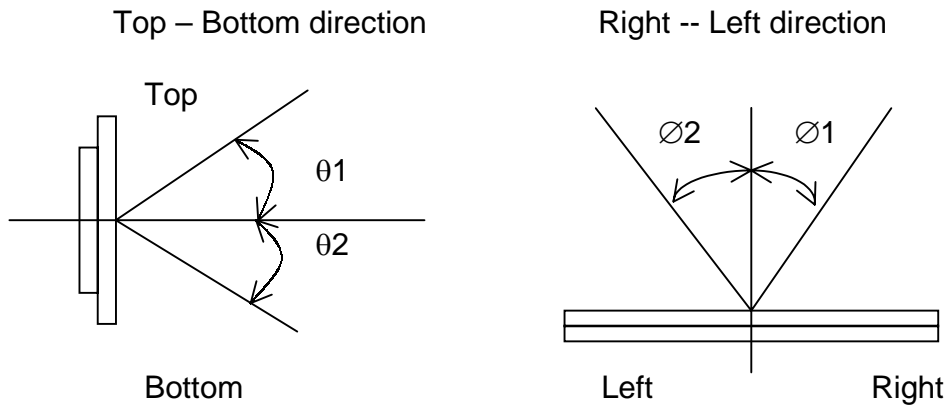
Note (1) Response time is measured as the shortest period of time possible between the change in state of an LCD segment as demonstrated below:



Condition:

- ( a ) . Temperature ----- $25^{\circ}C$
- ( b ) . Frame frequency ----- 64Hz
- ( c ) . View Angle -----  $\theta = 0^{\circ}, \varnothing = 0^{\circ}$
- ( d ) . Operating voltage ----- 6.2V

Note (2) Definition of View Angle



### 6.1 LED ELECTRO-OPTICAL CHARACTERISTIC

Ta = 25°C

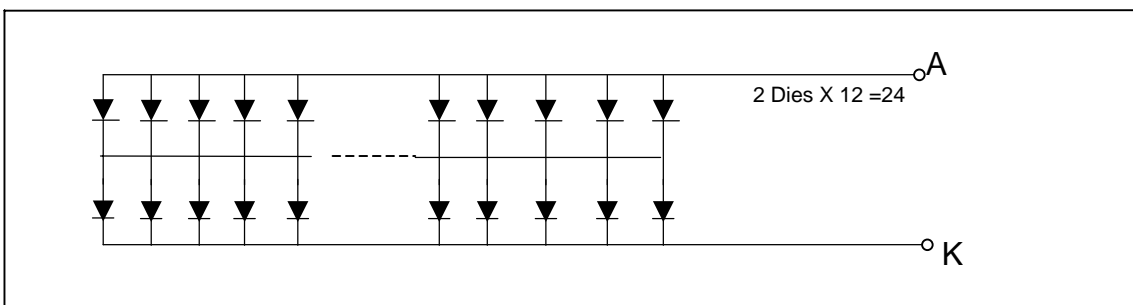
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 200mA Yellow Green	--	4.2	4.6	V
Luminous Intensity	I <sub>v</sub>	I <sub>F</sub> = 200mA Yellow Green	--	160	--	cd/m <sup>2</sup>
Peak Emission	λ <sub>P</sub>	I <sub>F</sub> = 200mA Yellow Green	--	573	575	nm
Spectrum Radiation	Δλ	I <sub>F</sub> = 200mA Yellow Green	--	30	--	nm
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 8V Yellow Green	--	--	0.2	mA

Note : Measured at the bared LED backlight unit.

### 6.2 LED MAXIMUM OPERATING RANGE

Item	Symbol	Yellow Green	Unit
Power Dissipation	P <sub>AD</sub>	0.85	W
Forward Current	I <sub>AF</sub>	300	mA
Reverse Voltage	V <sub>R</sub>	8	V

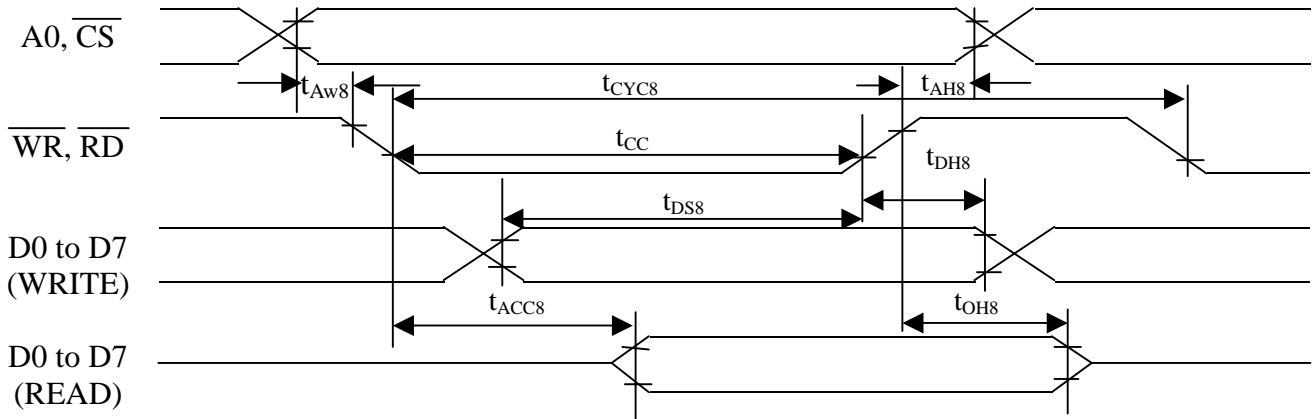
#### 6.2.1 LED ARRAY BLOCK DIAGRAM



## 7. TIMING CHARACTERISTICS

### AC Characteristics

#### MPU Bus Read/Write I (80 – family MPU)



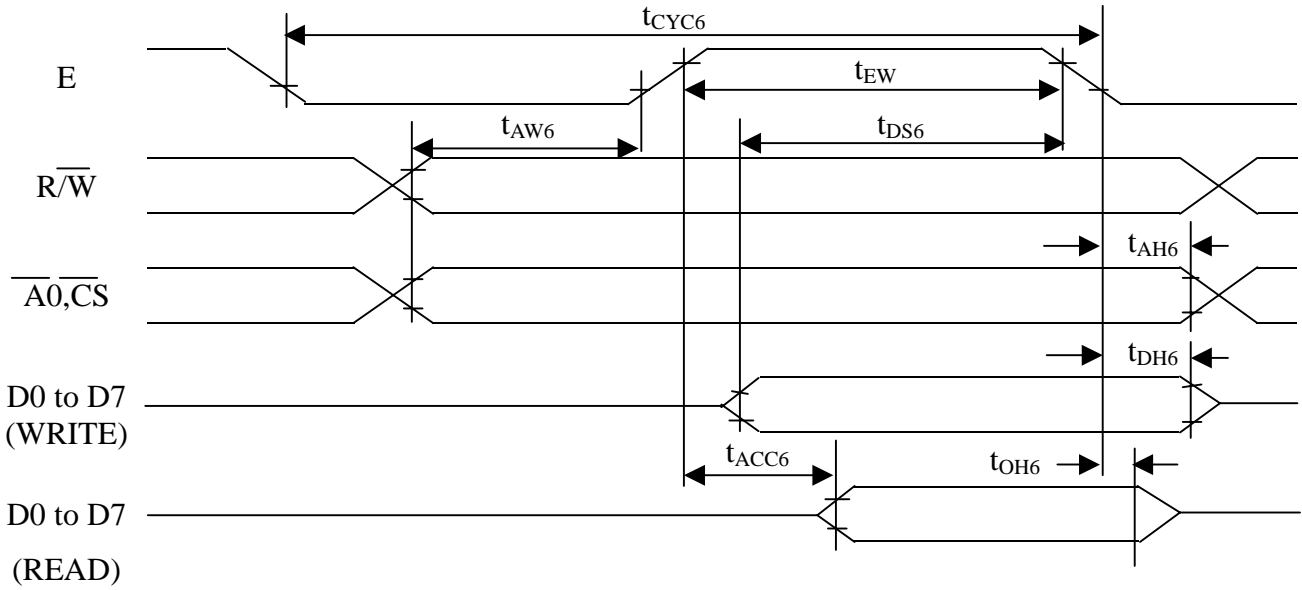
Ta = -20 to 75 °C, VSS = -5.0V ± 10% unless stated otherwise

Parameter	Symbol	Condition	Rating		Unit	Signal
			min	max		
Address hold time	t <sub>AH8</sub>		10	--	ns	A0, $\overline{CS}$
Address setup time	t <sub>AW8</sub>		20	--	ns	
System cycle time	t <sub>CYC8</sub>		1000	--	ns	$\overline{WR}, \overline{RD}$
Control pulse width	t <sub>CC</sub>		200	--	ns	
Data setup time	t <sub>DS8</sub>		80	--	ns	D0 to D7
Data hold time	t <sub>DH8</sub>		10	--	ns	
$\overline{RD}$ access time	t <sub>ACC8</sub>	CL = 100 PF	--	90	ns	
Output disable time	t <sub>CH8</sub>		10	60	ns	
Rise and fall time	t <sub>r</sub> , t <sub>f</sub>			15	ns	

(VSS=-2.7 to -4.5V Ta = -20 to 75 °C)

Parameter	Symbol	Condition	Rating		Unit	Signal
			min	max		
Address hold time	t <sub>AH8</sub>		20	--	ns	A0, $\overline{CS}$
Address setup time	t <sub>AW8</sub>		40	--	ns	
System cycle time	t <sub>CYC8</sub>		2000	--	ns	$\overline{WR}, \overline{RD}$
Control pulse width	t <sub>CC</sub>		400	--	ns	
Data setup time	t <sub>DS8</sub>		160	--	ns	D0 to D7
Data hold time	t <sub>DH8</sub>		20	--	ns	
$\overline{RD}$ access time	t <sub>ACC8</sub>	CL = 100 PF	--	180	ns	
Output disable time	t <sub>CH8</sub>		20	120	ns	
Rise and fall time	t <sub>r</sub> , t <sub>f</sub>			15	ns	

MPU Bus Read/Write II (68 – family MPU)



Ta = -20 to 75° C, VSS = -5.0V ± 10% unless stated otherwise

Parameter	Symbol	Condition	Rating		Unit	Signal
			min	max		
System cycle time	t <sub>CYC6</sub>		1000	--	ns	A0,CS, R/W
Address setup time	t <sub>AW6</sub>		20	--	ns	
Address hold time	t <sub>AH6</sub>		10	--	ns	
Data setup time	t <sub>DS6</sub>		80	--	ns	D0 to D7
Data hold time	t <sub>DH6</sub>		10	--	ns	
Output disable time	t <sub>OH6</sub>	CL = 100 PF	10	60	ns	
Access time	t <sub>ACC6</sub>		--	90	ns	
Enable Pulse width	t <sub>EW</sub>	Read	100		ns	
		Write	8		ns	
Rise and fall time	t <sub>r</sub> , t <sub>f</sub>			15	ns	

(VSS=-2.7 to -4.5V Ta = -20 to 75 ° C

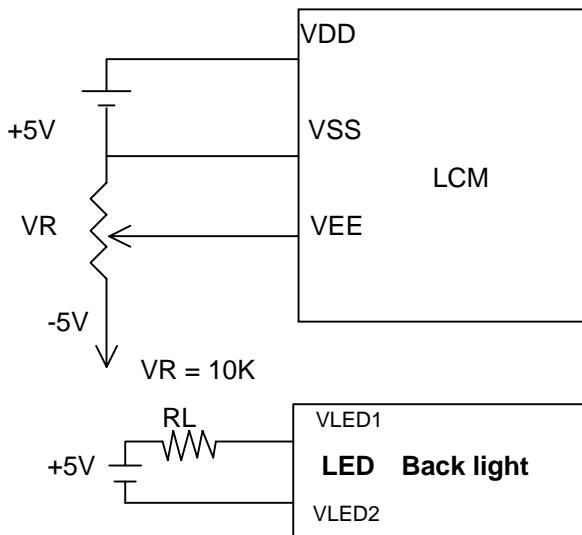
Parameter	Symbol	Condition	Rating		Unit	Signal
			min	max		
System cycle time	t <sub>CYC6</sub>		2000	--	ns	A0,CS, R/W
Address setup time	t <sub>AW6</sub>		40	--	ns	
Address hold time	t <sub>AH6</sub>		20	--	ns	
Data setup time	t <sub>DS6</sub>		160	--	ns	D0 to D7
Data hold time	t <sub>DH6</sub>		20	--	ns	
Output disable time	t <sub>OH6</sub>	CL = 100 PF	20	120	ns	
Access time	t <sub>ACC6</sub>		--	180	ns	
Enable Pulse width	t <sub>EW</sub>	Read	200		ns	
		Write	160		ns	
Rise and fall time	t <sub>r</sub> , t <sub>f</sub>			15	ns	

Notes : 1. t<sub>CYC6</sub> is the cycle time of CS. E = H, not the cycle time of E.

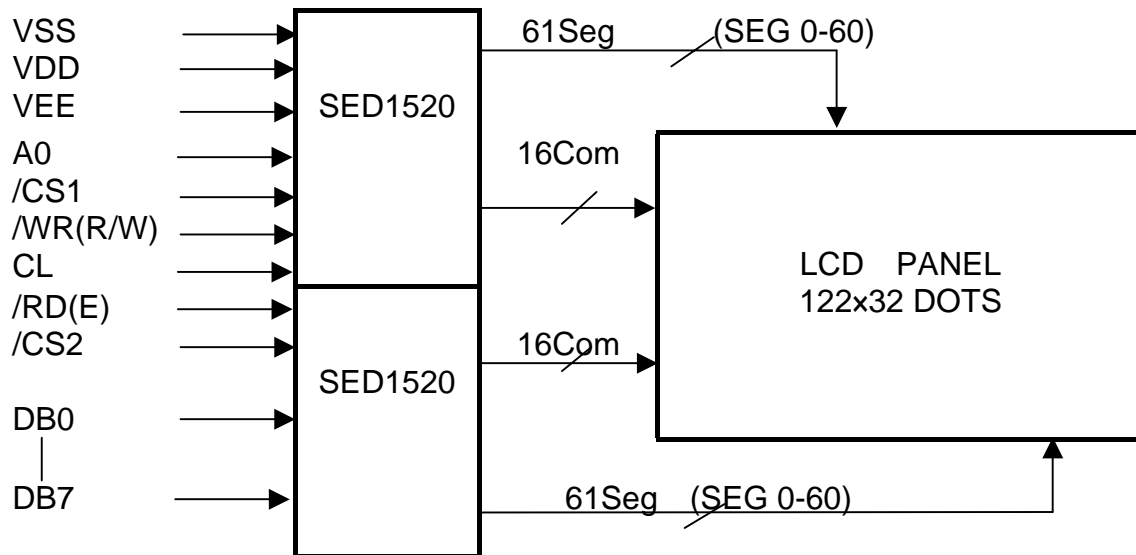
## 8. PIN CONNECTIONS

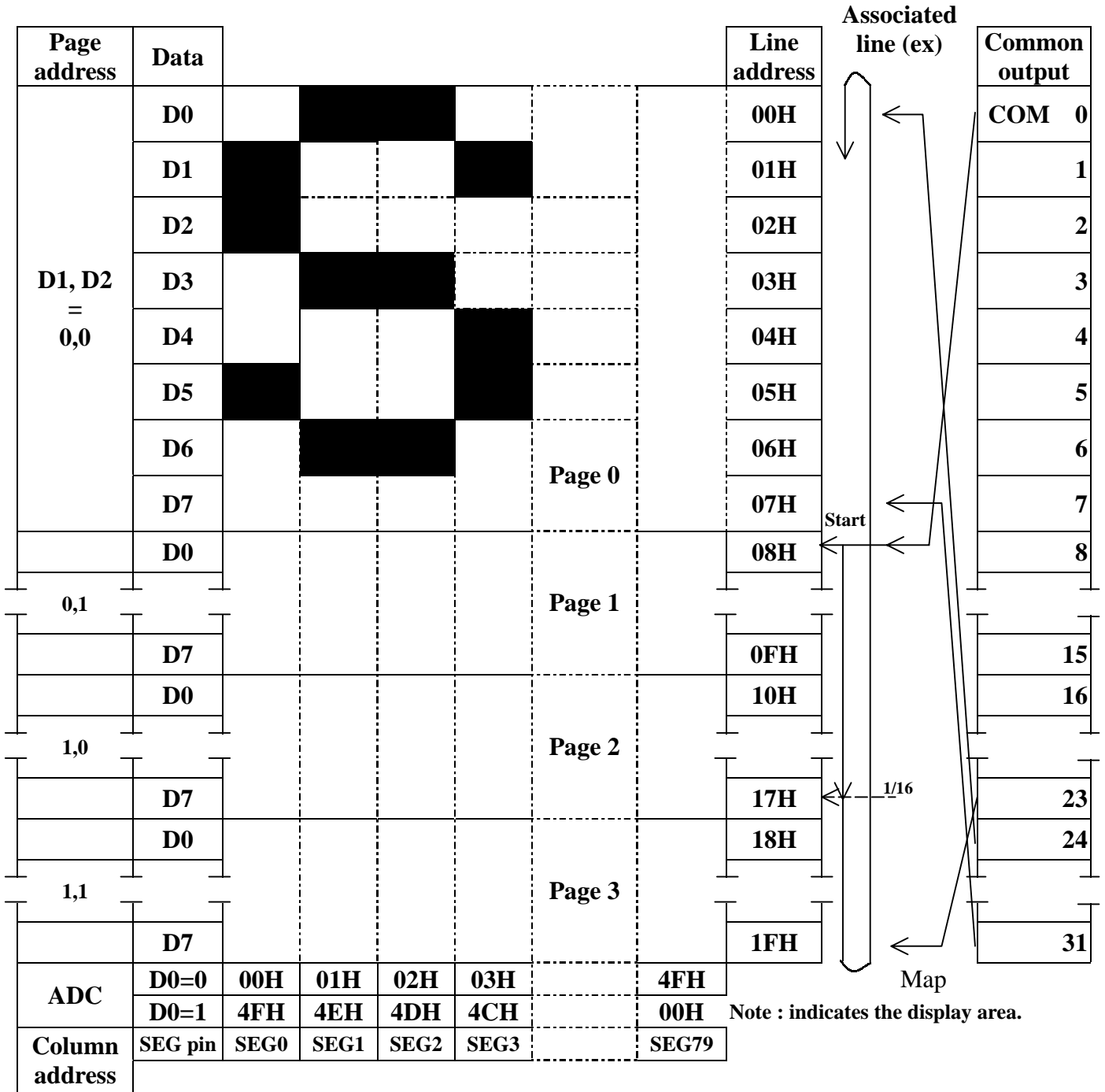
No.	Symbol	Function
1	VSS	Ground (0V)
2	VDD	+5V
3	VEE	Power Supply For LCD Drive
4	A0	L→ Instructions H→ Data
5	/CS1	Chip Enable Active "L"
6	/CS2	Chip Enable Active "L"
7	CL	External Clock Input (2K Hz)
8	/RD (E)	/RD for 80 series, E for 68 series
9	/WR (R/W)	/WR for 80 series, R/W for 68 series
10	DB0	Data Bus Line
11	DB1	
12	DB2	
13	DB3	
14	DB4	
15	DB5	
16	DB6	
17	DB7	
18	RES	Reset Signal, H→80 series, L→68 series
19	VLED1	Power Supply for LED Backlight
20	VLED2	

## 9. POWER SUPPLY



## 10. BLOCK DIAGRAM





### Display Data RAM Addressing

# COMMANDS

## Summary

Command	Code											Function	
	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0		
Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0/1	Turns display on or off. 1 : ON, 0 : OFF	
Display start line	0	1	0	1	1	0	Display start address (0 to 31)					Specifies RAM line corresponding to top line of display.	
Set page address	0	1	0	1	0	1	1	1	0	Page (0 to 3)		Sets display RAM page in page address register.	
Set column (segment) address	0	1	0	0	Column address (0 to 72)							Sets display RAM column address in column address register.	
Read status	0	0	1	Busy	ADC	ON/OFF	Reset	0	0	0	0	Reads the following status:	
												BUSY	1 : Busy 0 : Ready
												ADC	1 : CW output 0 : CCW output
												ON/OFF	1 : Display off 0 : Display on
RESET	1 : Being reset 0 : Normal												
Write display data	1	1	0	Write data							Writes data from data bus into display RAM.		
Read display data	1	0	1	Read data							Reads data from display RAM onto data bus.		
Select ADC	0	1	0	1	0	1	0	0	0	0	0/1	0 : CW output 1 : CCW output	
Static drive ON/OFF	0	1	0	1	0	1	0	0	1	0	0/1	Selets static driving operation. 1 : Static drive 0 : Normal driving	
Select duty	0	1	0	1	0	1	0	1	0	0	0/1	Selets LCD duty cycle 1 : 1/32 0 : 1/16	
Read – Modify - Write	0	1	0	1	1	1	0	0	0	0	0	Read – modify – write ON	
End	0	1	0	1	1	1	0	1	1	1	0	Read – modify – write OFF	
Reset	0	1	0	1	1	1	0	0	0	1	0	Software reset	

## 11. QUALITY ASSURANCE

### 11.1 Test Condition

#### 11.1.1 Temperature and Humidity (Ambient Temperature)

Temperature :  $20 \pm 5^{\circ}\text{C}$

Humidity :  $65 \pm 5\%$

#### 11.1.2 Operation

Unless specified otherwise, test will be conducted with LCM in operation.

#### 11.1.3 Container

Unless specified otherwise, vibration test will be conducted on module only.

#### 11.1.4 Test Frequency

Single cycle.

#### 11.1.5 Test Method

No.	Parameter	Conditions	Regulations
1	High Temperature Operating	$50 \pm 2^{\circ}\text{C}$	Note 3
2	Low Temperature Operating	$0 \pm 2^{\circ}\text{C}$	Note 3
3	High Temperature Storage	$70 \pm 2^{\circ}\text{C}$	Note 3
4	Low Temperature Storage	$-20 \pm 2^{\circ}\text{C}$	Note 3
5	Vibration Test (Non-operation state)	Total fixed amplitude : 1.5mm Vibration Frequency : 10 ~ 55Hz One cycle 60 seconds to 3 directions of X.Y.Z. for each 15 minutes	Note 3
6	Damp Proof Test (Non-operation state)	$40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 90~95%RH, 96h	Note 1,2
7	Shock Test (Non-operation state)	To be measured after dropping from 60cm high once concrete surface in packing state	Note 3

Note 1: Returned under normal temperature and humidity for 4 hrs.

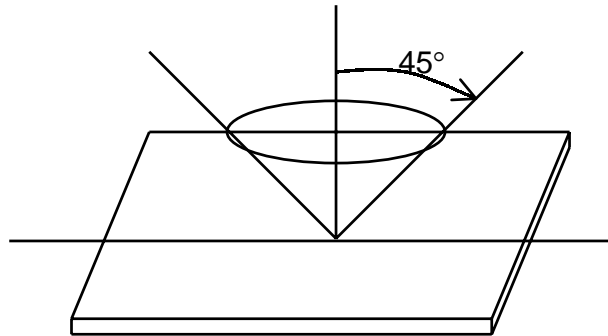
Note 2: No dew condensation to be observed.

Note 3: No change on display and in operation under the test condition

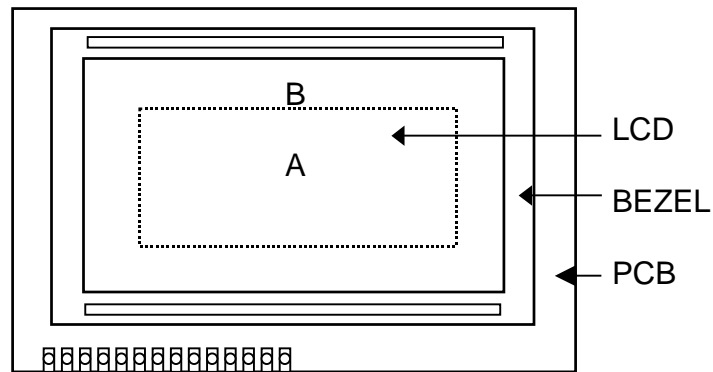
## 11.2 Inspection condition

### 11.2.1 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.



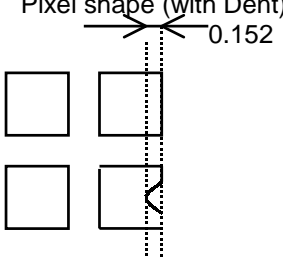
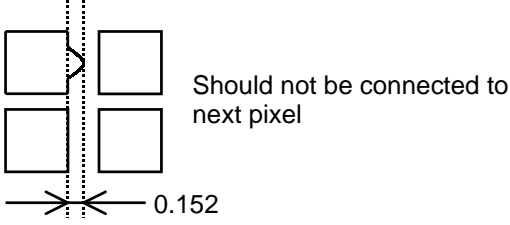
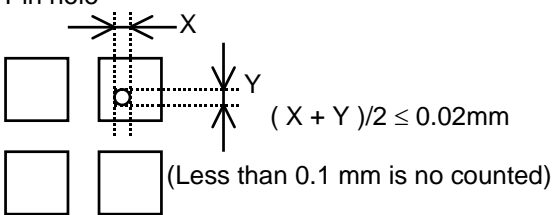
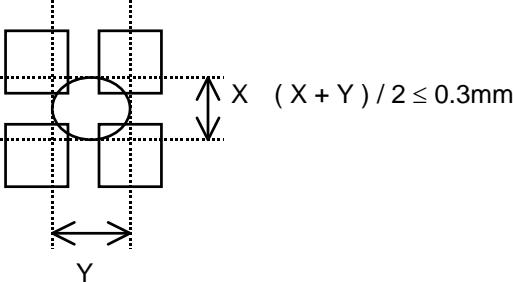
### 11.2.2 Definition of applicable Zones



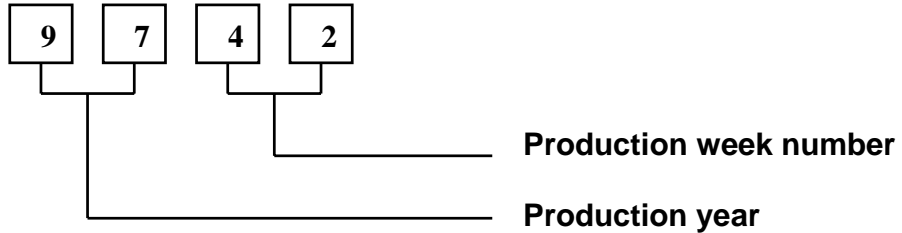
A : Display Area  
B : Non-Display Area

11.2.3 Inspection Parameters

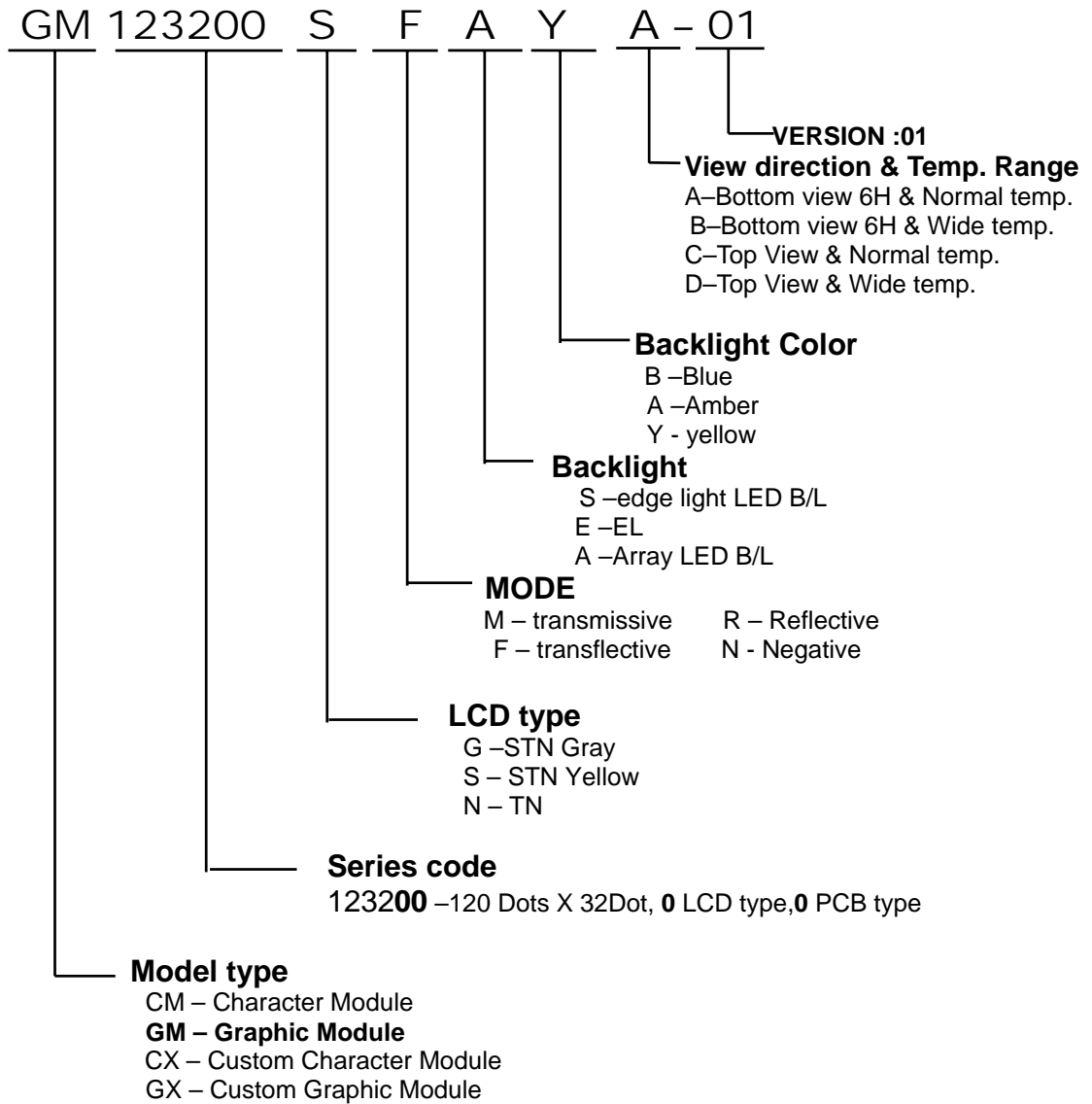
No.	Parameter	Criteria																										
1	Black or White spots	<table border="1"> <thead> <tr> <th rowspan="2">Zone Dimension</th> <th colspan="2">Acceptable number</th> <th rowspan="2">Class Of Defects</th> <th rowspan="2">Acceptable level</th> </tr> <tr> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>D &lt; 0.15</td> <td>*</td> <td>*</td> <td rowspan="4">Minor</td> <td rowspan="4">2.5</td> </tr> <tr> <td>0.15 ≤ D &lt; 0.2</td> <td>4</td> <td>4</td> </tr> <tr> <td>0.2 ≤ D ≤ 0.25</td> <td>2</td> <td>2</td> </tr> <tr> <td>D ≤ 0.3</td> <td>0</td> <td>1</td> </tr> </tbody> </table> <p>D = (Long + Short) / 2      * : Disregard</p>	Zone Dimension	Acceptable number		Class Of Defects	Acceptable level	A	B	D < 0.15	*	*	Minor	2.5	0.15 ≤ D < 0.2	4	4	0.2 ≤ D ≤ 0.25	2	2	D ≤ 0.3	0	1					
Zone Dimension	Acceptable number			Class Of Defects	Acceptable level																							
	A	B																										
D < 0.15	*	*	Minor	2.5																								
0.15 ≤ D < 0.2	4	4																										
0.2 ≤ D ≤ 0.25	2	2																										
D ≤ 0.3	0	1																										
2	Scratch, Substances	<table border="1"> <thead> <tr> <th rowspan="2">X (mm) Y (mm)</th> <th rowspan="2">Zone</th> <th colspan="2">Acceptable number</th> <th rowspan="2">Class Of Defects</th> <th rowspan="2">Accept-able level</th> </tr> <tr> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>*    0.04 ≥ W</td> <td></td> <td>*</td> <td>*</td> <td rowspan="4">Minor</td> <td rowspan="4">2.5</td> </tr> <tr> <td>3.0 ≥ L    0.06 ≥ W</td> <td></td> <td>4</td> <td>4</td> </tr> <tr> <td>2.0 ≥ L    0.08 ≥ W</td> <td></td> <td>2</td> <td>3</td> </tr> <tr> <td>—    0.1 &lt; W</td> <td></td> <td>0</td> <td>1</td> </tr> </tbody> </table> <p>X : Length    Y : Width      * : Disregard</p> <p>Total defects should not exceed 4/module</p>	X (mm) Y (mm)	Zone	Acceptable number		Class Of Defects	Accept-able level	A	B	*    0.04 ≥ W		*	*	Minor	2.5	3.0 ≥ L    0.06 ≥ W		4	4	2.0 ≥ L    0.08 ≥ W		2	3	—    0.1 < W		0	1
X (mm) Y (mm)	Zone	Acceptable number			Class Of Defects	Accept-able level																						
		A	B																									
*    0.04 ≥ W		*	*	Minor	2.5																							
3.0 ≥ L    0.06 ≥ W		4	4																									
2.0 ≥ L    0.08 ≥ W		2	3																									
—    0.1 < W		0	1																									
3	Air Bubbles (between glass & polarizer)	<table border="1"> <thead> <tr> <th rowspan="2">Zone Dimension</th> <th colspan="2">Acceptable number</th> <th rowspan="2">Class of Defects</th> <th rowspan="2">Acceptable Level</th> </tr> <tr> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>D ≤ 0.15</td> <td>*</td> <td>*</td> <td rowspan="3">Minor</td> <td rowspan="3">2.5</td> </tr> <tr> <td>0.15 &lt; D ≤ 0.25</td> <td>2</td> <td>*</td> </tr> <tr> <td>0.25 &lt; D</td> <td>0</td> <td>1</td> </tr> </tbody> </table> <p>* : Disregard</p> <p>Total defects shall not excess 3/module.</p>	Zone Dimension	Acceptable number		Class of Defects	Acceptable Level	A	B	D ≤ 0.15	*	*	Minor	2.5	0.15 < D ≤ 0.25	2	*	0.25 < D	0	1								
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<p>3</p>	<p>Uniformity of Pixel</p>	<p>(1) Pixel shape (with Dent)</p>  <p>(2) Pixel shape (with Projection)</p>  <p>(3) Pin hole</p>  <p>(4) Deformation</p>  <p>Total acceptable number : 1/pixel, 5/cell</p>
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## 12. LOT NUMBERING SYSTEM



## 13. LCM NUMBERING SYSTEM



## 14. PRECAUTION FOR USING LCM

### 1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handling,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzin.
- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handling, especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

### 2. Liquid Crystal Display Modules

#### 2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

#### 2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.
- (3). Only properly grounded soldering irons should be used.
- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

- (5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.
- (6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

#### 2.3 Soldering

- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature :  $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.
- (6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

#### 2.4 Operation

- (1). The viewing angle can be adjusted by varying the LCD driving voltage  $V_0$ .
- (2). Driving voltage should be kept within specified range; excess voltage shortens display life.
- (3). Response time increases with decrease in temperature.
- (4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- (5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

#### 2.5 Storage

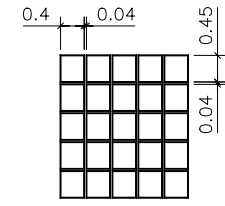
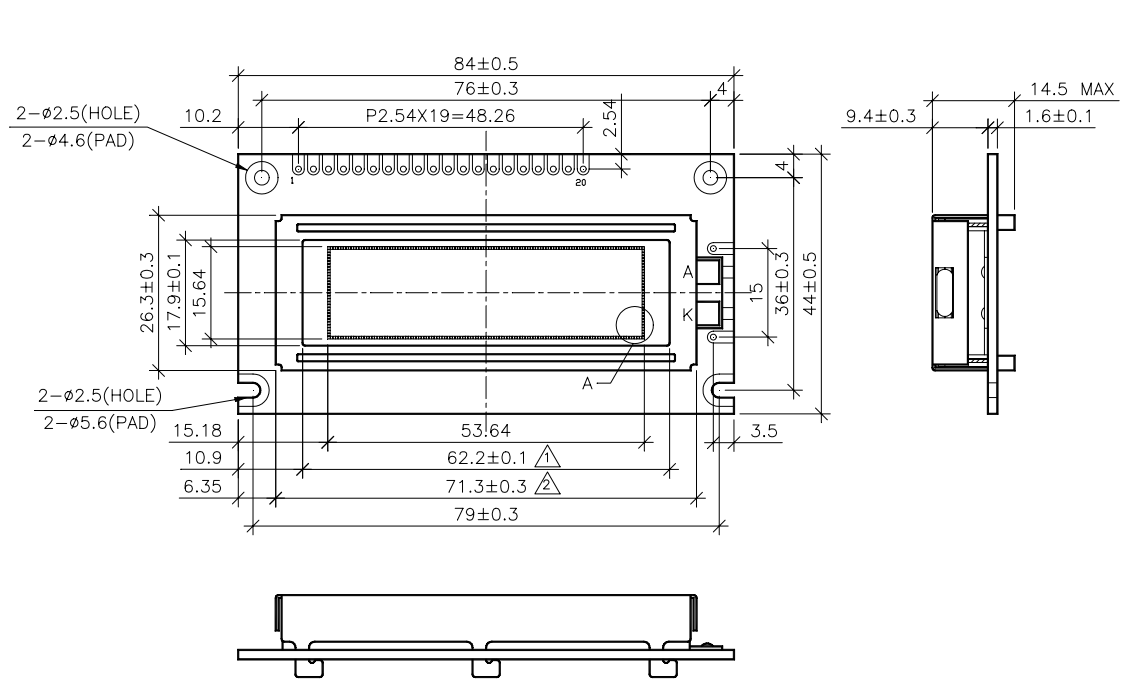
If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

#### 2.6 Limited Warranty

Unless otherwise agreed between DATA IMAGE and customer, DATA IMAGE will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with DATA IMAGE acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DATA IMAGE is limited to repair and/or replacement on the terms set forth above. DATA IMAGE will not responsible for any subsequent or consequential events.

# 15 OUTLINE DRAWING

UNITS MM



A BLOCK  
Scale:10/1

### PIN FUNCTIONS

1. VSS	11. DB1
2. VDD	12. DB2
3. VEE	13. DB3
4. AO	14. DB4
5. /CS1	15. DB5
6. /CS2	16. DB6
7. CL	17. DB7
8. /RD(E)	18. RES
9. /WR(R/W)	19. VLED1
10. DB0	20. VLED2

△Note: tolerance is ±0.3 unless otherwise noted.

## 16. PACKAGE INFORMATION

